

To our customers,

Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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J-FET INPUT LOW-NOISE QUAD OPERATIONAL AMPLIFIER

DESCRIPTION

The μ PC4074 is a J-FET input operational amplifier. This product is designed as low noise version of the μ PC4084. The features of the μ PC4074 are more improved input equivalent noise voltage, input offset voltage and input bias current than those of μ PC4084. By these features, the μ PC4074 is excellent choice for wide variety of applications including audio preamplifier and active filter.

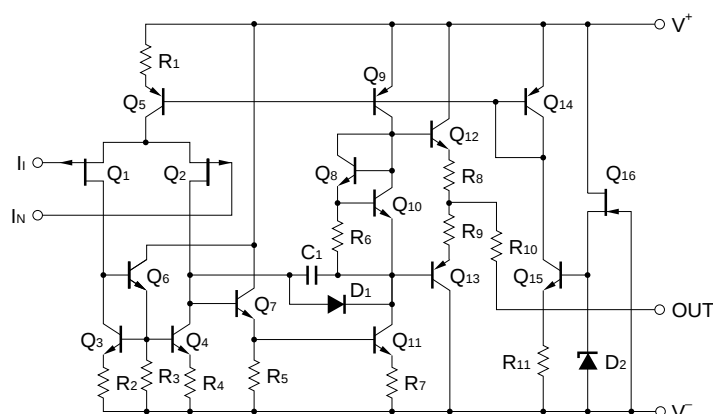
FEATURES

- Low noise: $e_n = 17 \text{ nV}/\sqrt{\text{Hz}}$ (TYP.)
- Very low input bias and offset currents
- Output short circuit protection
- High input impedance...J-FET Input stage
- Internal frequency compensation
- High slew rate...13 V/ μ s (TYP.)

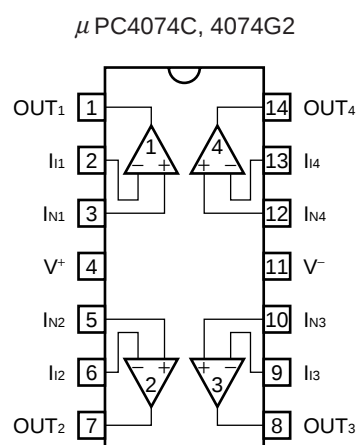
ORDERING INFORMATION

Part Number	Package
μ PC4074C	14-pin plastic DIP (7.62 mm (300))
μ PC4074G2	14-pin plastic SOP (5.72 mm (225))

EQUIVALENT CIRCUIT (1/4 Circuit)



PIN CONFIGURATION (Top View)



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ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

Parameter		Symbol	Ratings	Unit
Voltage between V ⁺ and V ⁻ ^{Note 1}		V ⁺ - V ⁻	-0.3 to +36	V
Differential Input Voltage		V _{ID}	±30	V
Input Voltage ^{Note 2}		V _I	V - 0.3 to V ⁺ + 0.3	V
Output Voltage ^{Note 3}		V _O	V - 0.3 to V ⁺ + 0.3	V
Power Dissipation	C Package ^{Note 4}	P _T	570	mW
	G2 Package ^{Note 5}		550	mW
Output Short Circuit Duration ^{Note 6}			Indefinite	sec
Operating Ambient Temperature		T _A	-20 to +80	°C
Storage Temperature		T _{stg}	-55 to +125	°C

Notes 1. Reverse connection of supply voltage can cause destruction.

2. The input voltage should be allowed to input without damage or destruction. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The normal operation will establish when the both inputs are within the Common Mode Input Voltage Range of electrical characteristics.
3. This specification is the voltage which should be allowed to supply to the output terminal from external without damage or destructive. Even during the transition period of supply voltage, power on/off etc., this specification should be kept. The output voltage of normal operation will be the Output Voltage Swing of electrical characteristics.
4. Thermal derating factor is -7.6 mW/°C when operating ambient temperature is higher than 50°C.
5. Thermal derating factor is -5.5 mW/°C when operating ambient temperature is higher than 25°C.
6. Pay careful attention to the total power dissipation not to exceed the absolute maximum ratings, Note 4 and Note 5.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	V [±]	±5		±16	V
Output Current	I _O			±10	mA
Capacitive Load (A _v = +1, R _f = 0 Ω)	C _L			100	pF

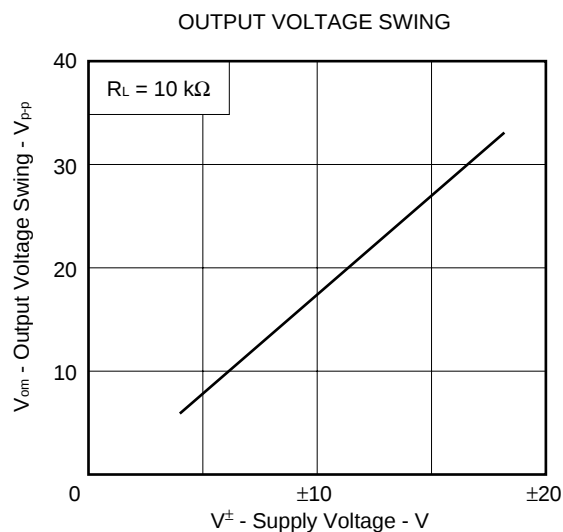
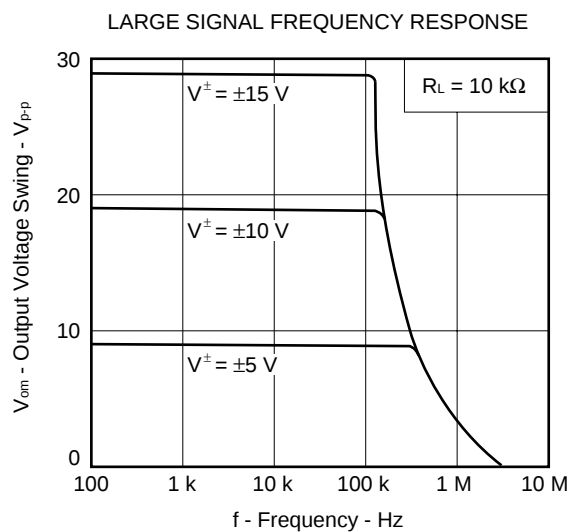
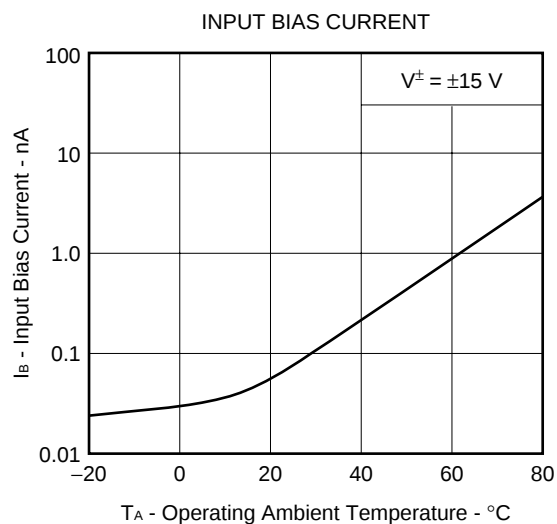
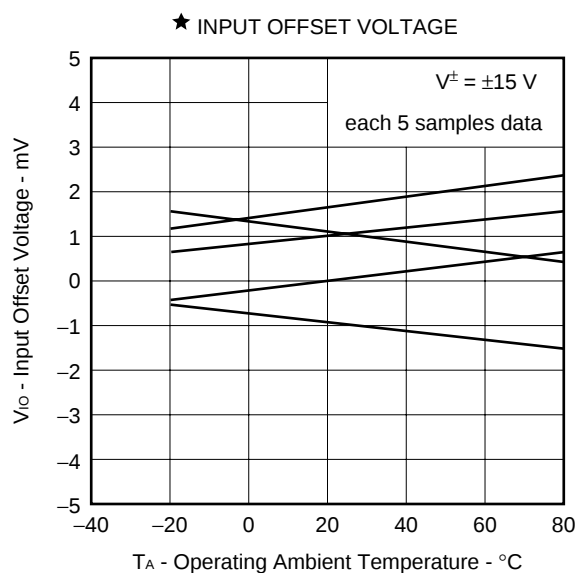
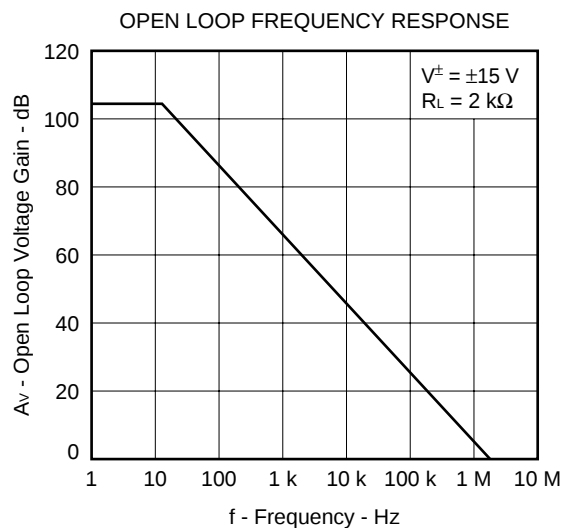
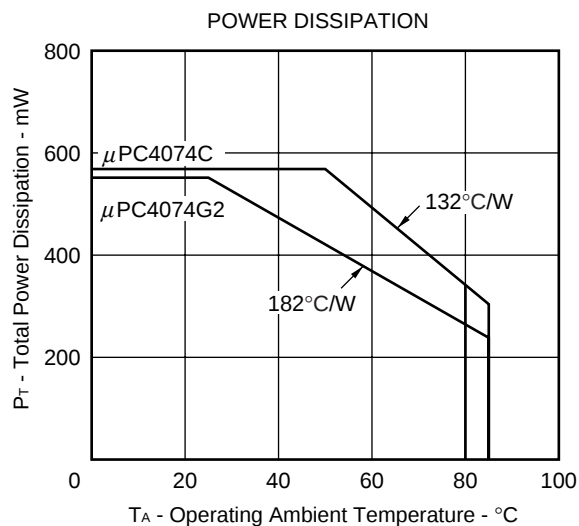
ELECTRICAL CHARACTERISTICS (T_A = 25°C, V[±] = ±15 V)

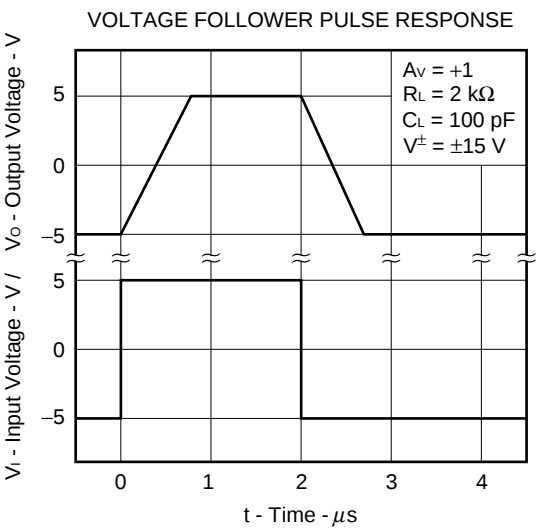
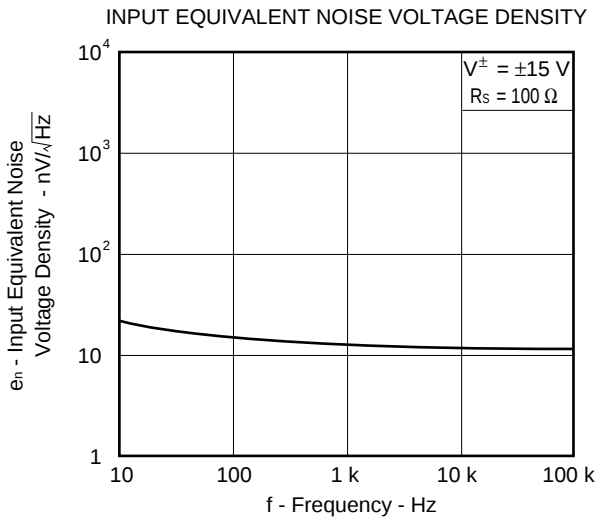
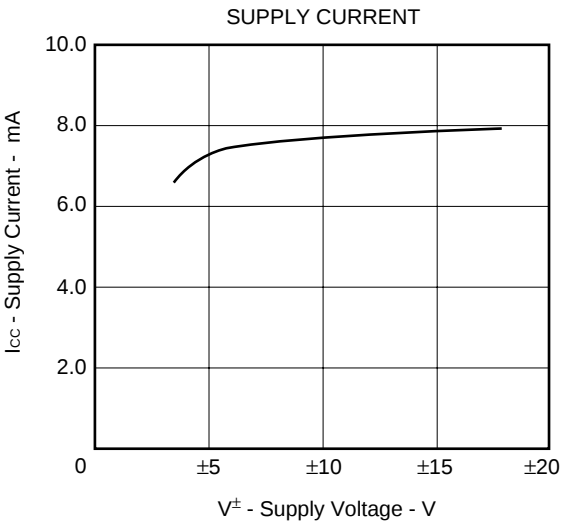
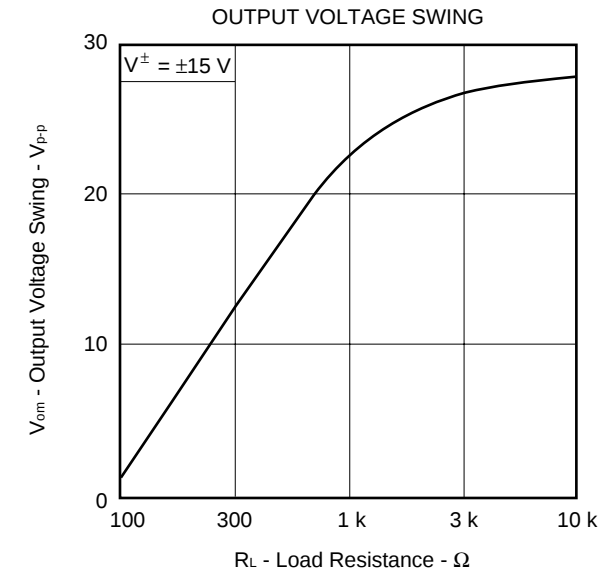
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input Offset Voltage	V _{IO}	R _S ≤ 50 Ω		±3	±10	mV
Input Offset Current ^{Note 7}	I _{IO}			±5	±50	pA
Input Bias Current ^{Note 7}	I _B			30	200	pA
Large Signal Voltage Gain	A _V	R _L ≥ 2 kΩ, V _O = ±10 V	25000	200000		
★ Supply Current ^{Note 8}	I _{CC}	I _O = 0 A		8	10	mA
Common Mode Rejection Ratio	CMR		70	86		dB
Supply Voltage Rejection Ratio	SVR		70	86		dB
Output Voltage Swing	V _{om}	R _L ≥ 10 kΩ	±12	±13.5		V
		R _L ≥ 2 kΩ	±10	±12		V
Common Mode Input Voltage Range	V _{ICM}		±10			V
Slew Rate	SR	A _V = 1		13		V/μs
Unity Gain Frequency	f _{unity}			3		MHz
Input Equivalent Noise Voltage	V _n	R _S = 100 Ω, f = 10 Hz to 10 kHz		4		μV _{r.m.s.}
Input Equivalent Noise Voltage Density	e _n	R _S = 100 Ω, f = 1 kHz		17		nV/√Hz
Channel Separation				120		dB
Input Offset Voltage	V _{IO}	R _S ≤ 50 Ω, T _A = -20 to +70°C			±13	mV
Average V _{IO} Temperature Drift	ΔV _{IO} /ΔT	T _A = -20 to +70°C		±10		μV/°C
Input Offset Current ^{Note 7}	I _{IO}	T _A = -20 to +70°C			±2	nA
Input Bias Current ^{Note 7}	I _B	T _A = -20 to +70°C			7	nA

Notes 7. Input bias currents flow into IC. Because each currents are gate leak current of P-channel J-FET on input stage. And that are temperature sensitive. Short time measuring method is recommendable to maintain the junction temperature close to the operating ambient temperature.

★ **8.** This current flows irrespective of the existence of use.

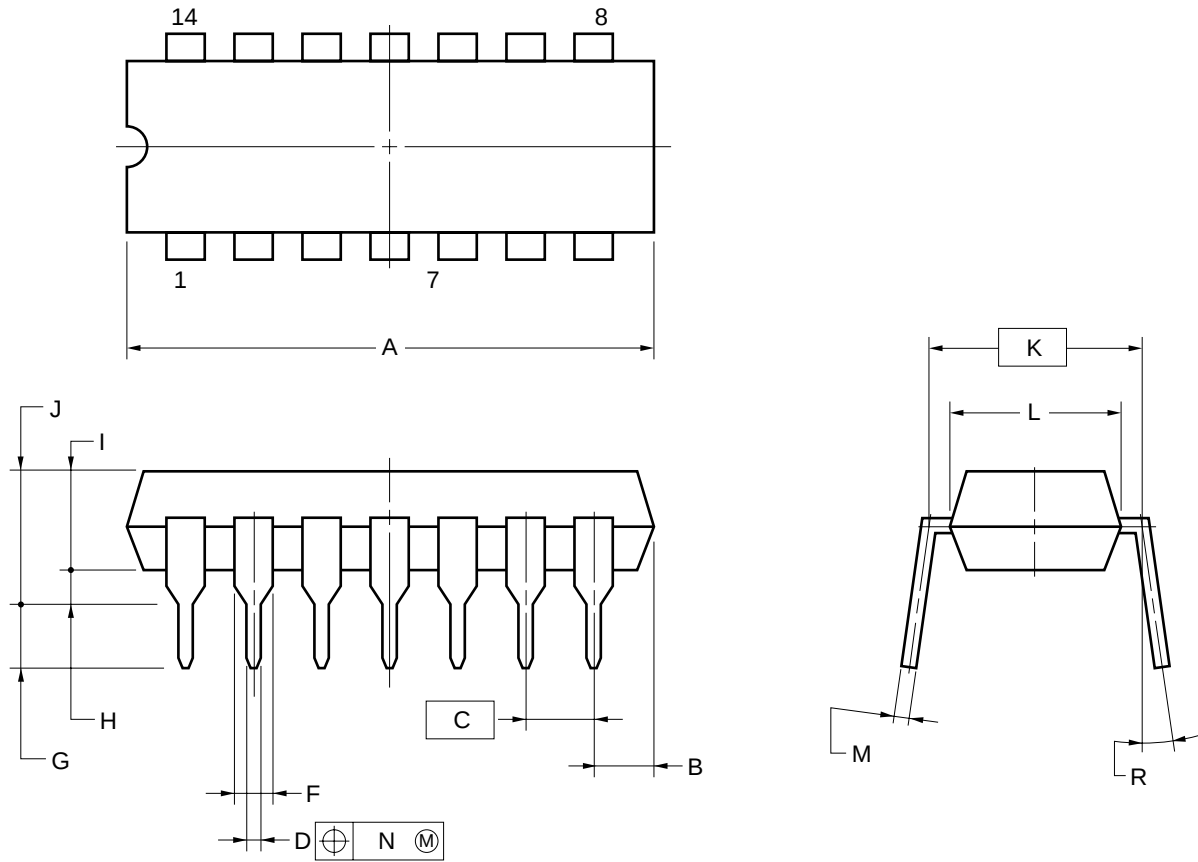
TYPICAL PERFORMANCE CHARACTERISTICS ($T_A = 25^\circ\text{C}$, TYP.)





PACKAGE DRAWINGS (Unit : mm)

14-PIN PLASTIC DIP (7.62 mm (300))



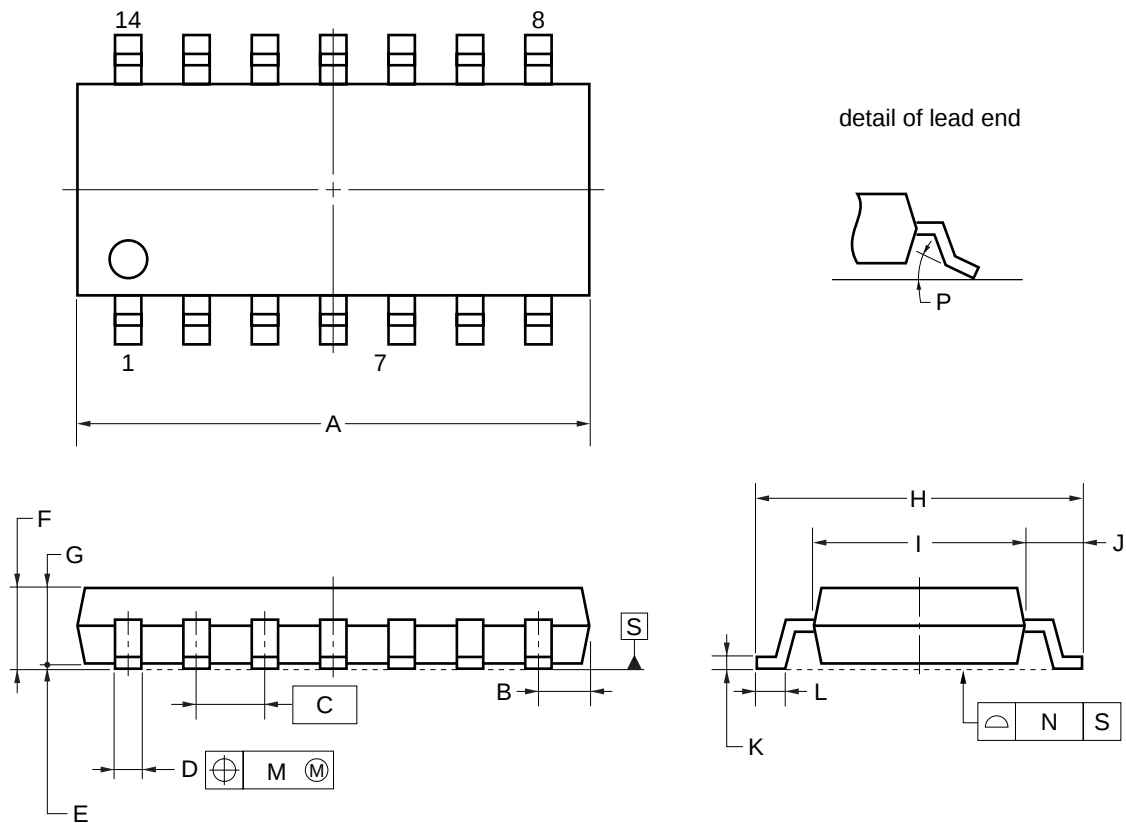
NOTES

1. Each lead centerline is located within 0.25 mm of its true position (T.P.) at maximum material condition.
2. Item "K" to center of leads when formed parallel.

ITEM	MILLIMETERS
A	19.22±0.2
B	2.14 MAX.
C	2.54 (T.P.)
D	0.50±0.10
F	1.32±0.12
G	3.6±0.3
H	0.51 MIN.
I	3.55
J	4.3±0.2
K	7.62 (T.P.)
L	6.4±0.2
M	0.25 ^{+0.10} _{-0.05}
N	0.25
R	0~15°

P14C-100-300B1-3

14-PIN PLASTIC SOP (5.72 mm (225))



NOTE
Each lead centerline is located within 0.1 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
A	10.2±0.26
B	1.42 MAX.
C	1.27 (T.P.)
D	0.42 ^{+0.08} _{-0.07}
E	0.1±0.1
F	1.59 ^{+0.21} _{-0.2}
G	1.49
H	6.5±0.2
I	4.4±0.1
J	1.1±0.16
K	0.17 ^{+0.08} _{-0.07}
L	0.6±0.2
M	0.1
N	0.10
P	3° ^{+7°} _{-3°}

S14GM-50-225B, C-6

★ RECOMMENDED SOLDERING CONDITIONS

The μPD4074 should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (<http://www.necel.com/pkg/en/mount/index.html>)

Type of Surface Mount Device

μPC4074G2: 14-pin plastic SOP (5.72 mm (225))

Process	Conditions	Symbol
Infrared Ray Reflow	Peak temperature: 230°C or below (Package surface temperature), Reflow time: 30 seconds or less (at 210°C or higher), Maximum number of reflow processes: 1 time.	IR30-00-1
Vapor Phase Soldering	Peak temperature: 215°C or below (Package surface temperature), Reflow time: 40 seconds or less (at 200°C or higher), Maximum number of reflow processes: 1 time.	VP15-00-1
Wave Soldering	Solder temperature: 260°C or below, Flow time: 10 seconds or less, Maximum number of flow processes: 1 time, Pre-heating temperature: 120°C or below (Package surface temperature).	WS60-00-1
Partial Heating Method	Pin temperature: 300°C or below, Heat time: 3 seconds or less (Per each side of the device).	—

Caution Apply only one kind of soldering condition to a device, except for "partial heating method", or the device will be damaged by heat stress.

Type of Through-hole Device

μPC4074C: 14-pin plastic DIP (7.62 mm (300))

Process	Conditions
Wave Soldering (only to leads)	Solder temperature: 260°C or below, Flow time: 10 seconds or less.
Partial Heating Method	Pin temperature: 300°C or below, Heat time: 3 seconds or less (per each lead).

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

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